

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10806923			
<b>Filing Date:</b>	22-Mar-2004			
<b>Title of Invention:</b>	METHODS OF DEPOSITING SILICON DIOXIDE COMPRISING LAYERS IN THE FABRICATION OF INTEGRATED CIRCUITRY, METHODS OF FORMING TRENCH ISOLATION, AND METHODS OF FORMING ARRAYS OF MEMORY CELLS			
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<b>Filer:</b>	Paul Steven Holdaway			
<b>Attorney Docket Number:</b>	MI22-2274			
Filed as Large Entity				
<b>Utility      Filing Fees</b>				
<b>Description</b>	<b>Fee Code</b>	<b>Quantity</b>	<b>Amount</b>	<b>Sub-Total in USD(\$)</b>
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
Post-Allowance-and-Post-Issuance:				
Certificate of correction	1811	1	100	100
<b>Extension-of-Time:</b>				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				100